

Electronic Patent Application Fee Transmittal

Application Number:	10644195			
Filing Date:	20-Aug-2003			
Title of Invention:	Method of forming silicon-containing insulation film having low dielectric constant and low film stress			
First Named Inventor:	Yasuyoshi Hyodo			
Filer:	Katsuhiro Arai/Keiko Kinoshita (KOA)			
Attorney Docket Number:	ASMJP.137AUS			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				
Extension - 1 month with \$0 paid	1251	1	120	120

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				120